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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Tsai, et al.

Serial No.: 09/961,134

Filed: September 21, 2001

Confirmation No.: 4110

For: Method and Apparatus for  
Forming Metal Layers

Assistant Commissioner for  
Patents  
Washington, D.C. 20231

Dear Sir:

§§§§§ Group Art Unit: 1741

§§§§§ Examiner: Unknown

**CERTIFICATE OF MAILING**  
37 CFR 1.8

I hereby certify that this correspondence is being deposited on 4/15, 2002 with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231

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**REQUEST FOR CORRECTION OF ERROR ON FILING RECEIPT**

The Filing Receipt for the above-referenced application contains an error regarding the addressee section. Please delete [3050 Bowers Avenue] from the addressee section. The addressee section should read:

Patent Counsel  
Applied Materials, Inc.  
P.O. Box 450A  
Santa Clara, CA 95052.

Attached is a copy of the Filing Receipt with the above change noted thereon. Please correct this error or notify the applicants of the reasons for denying the request.

Respectfully submitted,

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/961,134 ✓	09/21/2001 ✓	1741 ✓	710 ✓	5262/CMP/CMP/RKK ✓	6 ✓	8 ✓	1 ✓

CONFIRMATION NO. 4110 ✓

## FILING RECEIPT



Patent Counsel  
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## Applicant(s)

✓ Stan Tsai, Fremont, CA; ✓  
✓ Shijian Li, San Jose, CA; ✓

## Assignment For Published Patent Application

Applied Materials, Inc.; ✓

## Domestic Priority data as claimed by applicant

## Foreign Applications

If Required, Foreign Filing License Granted 10/23/2001

Projected Publication Date: 03/27/2003

Non-Publication Request: No

Early Publication Request: No

## Title

Method and apparatus for forming metal layers ✓

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